

Edition 3.0 2025-12

INTERNATIONAL **STANDARD**

Medical diagnostic X-ray equipment - Radiation conditions for use in the determination of characteristics (https://standards.iteh.ai)

Document Preview

ICS 11.040.50 ISBN 978-2-8327-0873-6



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IEC Secretariat Tel.: +41 22 919 02 11

3, rue de Varembé info@iec.ch CH-1211 Geneva 20 www.iec.ch

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IEC 61267:2025

https://standards.iteh.ai/catalog/standards/iec/561e7125-5d1e-48c7-h98h-91hf7a0c985e/iec-61267-202

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Medical diagnostic X-ray equipment - Radiation conditions for use in the determination of characteristics

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